

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>JiHoon Oh</td><td>05/30/2008</td></tr><tr><td>KyuWon Lee</td><td>05/30/2008</td></tr><tr><td>Jaehyun Lim</td><td>05/30/2008</td></tr><tr><td>JongVin Park</td><td>05/30/2008</td></tr><tr><td>SinJae Lee</td><td>05/30/2008</td></tr></tbody></table>	Name	Execution Date	JiHoon Oh	05/30/2008	KyuWon Lee	05/30/2008	Jaehyun Lim	05/30/2008	JongVin Park	05/30/2008	SinJae Lee	05/30/2008	
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Jaehyun Lim	05/30/2008												
JongVin Park	05/30/2008												
SinJae Lee	05/30/2008												
RECEIVING PARTY DATA													
Name:	STATS ChipPAC Ltd.												
Street Address:	5 Yishun Street 23												
City:	Singapore												
State/Country:	SINGAPORE												
Postal Code:	768442												
PROPERTY NUMBERS Total: 1													
<table border="1"><thead><tr><th>Property Type</th><th>Number</th></tr></thead><tbody><tr><td>Application Number:</td><td>12131038</td></tr></tbody></table>	Property Type	Number	Application Number:	12131038									
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CORRESPONDENCE DATA													
Fax Number: (408)738-0881 <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>													
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Email: efiling@ishimarulaw.com													
Correspondent Name: Mikio Ishimaru													
Address Line 1: Law Offices of Mikio Ishimaru													
Address Line 2: 333 W. El Camino Real, Suite # 330													
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ATTORNEY DOCKET NUMBER:	27-531												
NAME OF SUBMITTER:	Mikio Ishimaru												

CH \$40.00 12131038

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PATENT
REEL: 021068 FRAME: 0367

Total Attachments: 3

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ASSIGNMENT

WHEREAS, the undersigned (hereinafter termed Assignor(s)) has/have invented certain new and useful improvements in

PACKAGE-ON-PACKAGE SYSTEM WITH HEAT SPREADER

for which a United States patent application has been executed on or before the date of this assignment;

WHEREAS, STATS ChipPAC Ltd., a Corporation of the Republic of Singapore, having a place of business at 5 Yishun Street 23, Singapore 768442 (hereinafter termed Assignee), is desirous of acquiring the entire right, title and interest in and to said application and said invention and improvements thereon, and in and to Letters Patents thereon when granted in the United States and foreign countries;


NOW, THEREFORE, for good and valuable consideration received by said Assignor(s) from said Assignee, the receipt of which is hereby acknowledged by said Assignor(s):

1. Said Assignor(s) does hereby sell, assign, transfer and convey unto said Assignee, the entire right, title and interest in and to said application and said invention and in and to any and all improvements on said invention and in and to any and all improvements on said invention heretofore or hereafter made or acquired by said Assignor(s); and in and to any and all Letters Patent on said invention and/or said improvements that may be granted in the United States or any foreign country, including each and every Letters Patent granted on any application which is a division, continuation, substitution, renewal, or continuation-in-part of any said application, and in and to each and every reissue or extension of said Letters Patent.
2. Said Assignor(s) hereby covenants and agrees to cooperate with said Assignee where said Assignee may enjoy to the fullest extent the right, title and interest herein conveyed. Such cooperation shall include (a) prompt execution of all papers (prepared at the expense of Assignee) which are deemed necessary or desirable by Assignee to perfect in it the right, title and interest herein conveyed, (b) prompt execution of all petitions, oaths, specifications or other papers (prepared at the expense of Assignee) which are deemed necessary or desirable by assignee for prosecuting said application, for filing and prosecuting divisional, continuation, substitution, renewal, continuation-in-part, or additional applications in the United States and/or foreign countries covering said invention and/or said improvements, for filing and prosecuting applications for reissuance of letters patent included herein, or for interference proceedings involving said invention and/or said improvements and (c) prompt assistance and cooperation in the prosecution of interference proceedings involving said invention and/or said improvements and in the adjudication of said Letters Patent, particularly by the disclosure of facts and the production of evidence relating to said invention and/or said improvements, provided the expenses which may be incurred by said Assignor(s) in lending such assistance and cooperation shall be paid by the Assignee.
3. The terms, covenants and conditions of this assignment shall inure to the benefit of said Assignee, its successors, assigns and/or other legal representatives and shall be binding upon said Assignor(s), his/her heirs, legal representatives and assigns.
4. Said Assignor(s) hereby warrants and represents that he/she has not entered into any assignment, contract or understanding in conflict herewith.

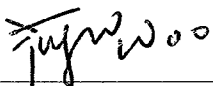
5. Said Assignor(s) hereby authorize and request the attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow:

Serial Number: 12/131,038 Filing Date: May 30, 2008.

IN WITNESS WHEREOF, the said Assignor has executed and delivered this instrument on the date set forth below.



JiHoon Oh




Witness Signature
HA SongWoo

Print Witness Name
30 May 2008

Date

30 May 2008

Date




Witness Signature
Choi Dae Sik


Print Witness Name
30, May, 2008

Date

IN WITNESS WHEREOF, the said Assignor has executed and delivered this instrument on the date set forth below.



KyuWon Lee




Witness Signature
HA SongWoo

Print Witness Name
30 May 2008

Date

30 MAY 2008.

Date




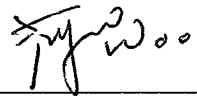
Witness Signature
Choi Dae Sik

Print Witness Name
30, May, 2008

Date

IN WITNESS WHEREOF, the said Assignor has executed and delivered this instrument on the date set forth below.




Jaehyun Lim


Witness Signature
HA SongWoo

Print Witness Name
30 May 2008

Date

30 May 2008

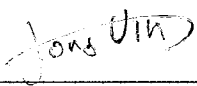
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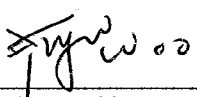
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Print Witness Name
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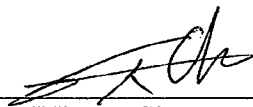
JongVin Park


Witness Signature
HA SongWoo

Print Witness Name
30 May 2008

Date

30 May 2008


Date


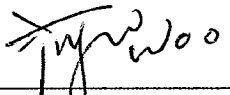
Witness Signature
Choi Dae Sik

Print Witness Name
30 May. 2008

Date

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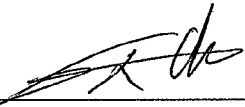
SinJae Lee


Witness Signature
HA SongWoo

Print Witness Name
30 May 2008

Date

30 May 2008

Date


Witness Signature
Choi Dae Sik

Print Witness Name
30 May. 2008

Date